

August 1993 Revised April 1999

# 74VHC175 Quad D-Type Flip-Flop

#### **General Description**

The VHC175 is an advanced high-speed CMOS device fabricated with silicon gate CMOS technology. It achieves the high-speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The VHC175 is a high-speed quad D-type flip-flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D inputs is stored during the LOW-to-HIGH clock transition. Both true and complemented outputs of each flip-flop are provided. A Master Reset input resets all flip-flops, independent of the Clock or D inputs, when LOW.

An input protection circuit insures that 0V to 7V can be applied to the input pins without regard to the supply volt-

age. This device can be used to interface 5V to 3V systems and two supply systems such as battery backup. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

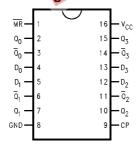
- High Speed:  $f_{MAX} = 210 \text{ MHz (typ)}$  at  $V_{CC} = 5V$
- $\blacksquare$  Low power dissipation:  $I_{CC}=4~\mu\text{A}$  (max) at  $T_{A}=25^{\circ}\text{C}$
- $\blacksquare$  High noise immunity:  $V_{NIH} = V_{NIL} = 28\%~V_{CC}$  (min)
- Power down protection is provided on all inputs
- Low noise: V<sub>OLP</sub> = 0.8V (max)
- Pin and function compatible with 74HC175

## **Ordering Code:**

Order Number	Package Number	Package Description
74VHC175M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
74VHC175SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74VHC175MTC	MTC16	16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74VHC175N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

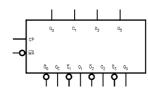
#### **Connection Diagram**

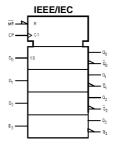


#### **Pin Descriptions**

Pin Names	Description			
D <sub>0</sub> –D <sub>3</sub>	Data Inputs			
CP	Clock Pulse Input			
MR	Master Reset Input			
$Q_0$ – $Q_3$	True Outputs			
$\overline{Q}_0$ – $\overline{Q}_3$	Complement Outputs			

## **Logic Symbols**





## **Functional Description**

The VHC175 consists of four edge-triggered D flip-flops with individual D inputs and Q and  $\overline{\bf Q}$  outputs. The Clock and Master Reset are common. The four flip-flops will store the state of their individual D inputs on the LOW-to-HIGH clock (CP) transition, causing individual Q  $\underline{\text{and}}\ \overline{\text{Q}}$  outputs to follow. A LOW input on the Master Reset (MR) will force all Q outputs LOW and  $\overline{Q}$  outputs HIGH independent of Clock or Data inputs. The VHC175 is useful for general logic applications where a common Master Reset and Clock are

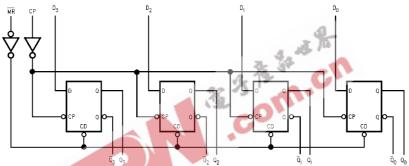
## **Truth Table**

Inputs	Outputs				
$@ t_n, \overline{MR} = H$	@ t <sub>n+1</sub>				
D <sub>n</sub>	Q <sub>n</sub>	$\overline{Q}_n$			
L	L	Н			
Н	Н	L			

H = HIGH Voltage Level L = LOW Voltage Level t<sub>n</sub> = Bit Time before Clock Pulse

 $t_{n+1} = Bit Time after Clock Pulse$ 

## **Logic Diagram**



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays

## **Absolute Maximum Ratings**(Note 1)

Supply Voltage (V<sub>CC</sub>) -0.5V to +7.0V DC Input Voltage (V<sub>IN</sub>) -0.5V to +7.0V DC Output Voltage (V<sub>OUT</sub>) -0.5V to  $V_{CC} + 0.5V$ Input Diode Current (I<sub>IK</sub>) -20 mA Output Diode Current (I<sub>OK</sub>) ±20 mA DC Output Current (I<sub>OUT</sub>) ±25 mA DC V<sub>CC</sub>/GND Current (I<sub>CC</sub>) ±50 mA Storage Temperature (T<sub>STG</sub>) -65°C to +150°C

Lead Temperature  $(T_L)$ 

(Soldering, 10 seconds) 260°C

# **Recommended Operating Conditions** (Note 2)

Input Rise and Fall Time (t<sub>r</sub>, t<sub>f</sub>)

 $V_{CC} = 3.3 V \pm 0.3 V$  0 ~ 100 ns/V  $V_{CC} = 5.0 V \pm 0.5 V$  0 ~ 20 ns/V

Note 1: Absolute Maximum Ratings are values beyond which the device may be damaged or have its useful life impaired. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation outside databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

#### **DC Electrical Characteristics**

Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = 25°C  Min Typ Max		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions		
Syllibol	Parameter	(V)			Max	Min Max		UIIIIS	Conditions	
V <sub>IH</sub>	HIGH Level Input	2.0	1.50			1.50	d.		ja .	
	Voltage	3.0 – 5.5	$0.7~\mathrm{V_{CC}}$		20	0.7 V <sub>CC</sub>		V		
V <sub>IL</sub>	LOW Level Input	2.0			0.50		0.50	V		
	Voltage	3.0 - 5.5			0.3 V <sub>CC</sub>	_0	0.3 V <sub>CC</sub>	\ \		
V <sub>OH</sub>	HIGH Level Output	2.0	1.9	2.0		1.9			$V_{IN} = V_{IH}$	$I_{OH} = -50 \mu A$
	Voltage	3.0	2.9	3.0		2.9		V	or V <sub>IL</sub>	
		4.5	4.4	4.5		4.4				
		3.0	2.58			2.48		V		$I_{OH} = -4 \text{ mA}$
		4.5	3.94			3.80		· ·		$I_{OH} = -8 \text{ mA}$
V <sub>OL</sub>	LOW Level Output	2.0		0.0	0.1		0.1		$V_{IN} = V_{IH}$	$I_{OL} = 50 \mu A$
	Voltage	3.0		0.0	0.1		0.1	V	or V <sub>IL</sub>	
		4.5		0.0	0.1		0.1			
		3.0			0.36		0.44	V		I <sub>OL</sub> = 4 mA
		4.5			0.36		0.44	· ·		$I_{OL} = 8 \text{ mA}$
I <sub>IN</sub>	Input Leakage Current	0 – 5.5			±0.1		±1.0	μΑ	$V_{IN} = 5.5 V o$	r GND
I <sub>CC</sub>	Quiescent Supply Current	5.5			4.0		40.0	μΑ	$V_{IN} = V_{CC}$ or	GND

#### **Noise Characteristics**

Symbol	Parameter	$v_{cc}$	T <sub>A</sub> =	25°C	Units	Conditions			
	T drameter	(V)	Тур	Limits	Onito	Conditions			
V <sub>OLP</sub> (Note 3)	Quiet Output Maximum Dynamic V <sub>OL</sub>	5.0	0.4	0.8	V	C <sub>L</sub> = 50 pF			
V <sub>OLV</sub> (Note 3)	Quiet Output Minimum Dynamic V <sub>OL</sub>	5.0	-0.4	-0.8	V	C <sub>L</sub> = 50 pF			
V <sub>IHD</sub> (Note 3)	Minimum HIGH Level Dynamic Input Voltage	5.0		3.5	V	C <sub>L</sub> = 50 pF			
V <sub>ILD</sub> (Note 3)	Maximum LOW Level Dynamic Input Voltage	5.0		1.5	V	$C_L = 50 \text{ pF}$			

Note 3: Parameter guaranteed by design.

## **AC Electrical Characteristics**

Symbol	Parameter	v <sub>cc</sub>	$T_A = 25^{\circ}C$			$T_A = -40$ °C to $+85$ °C		Units	Conditions
.,	, arameter	(V)	Min	Тур	Max	Min	Max	Oiiiio	
f <sub>MAX</sub>	Maximum Clock	$3.3 \pm 0.3$	90	140		75		MHz	C <sub>L</sub> = 15 pF
	Frequency		50	75		45		IVITIZ	C <sub>L</sub> = 50 pF
		$5.0 \pm 0.5$	150	210		125		MHz	C <sub>L</sub> = 15 pF
			85	115		75		IVITIZ	C <sub>L</sub> = 50 pF
t <sub>PLH</sub>	Propagation Delay	$3.3 \pm 0.3$		7.5	11.5	1.0	13.5	ns	C <sub>L</sub> = 15 pF
t <sub>PHL</sub>	Time (CP to $Q_n$ or $\overline{Q}_n$ )			10.0	15.0	1.0	17.0	ns	C <sub>L</sub> = 50 pF
		$5.0 \pm 0.5$		4.8	7.3	1.0	8.5	ns	C <sub>L</sub> = 15 pF
				6.3	9.3	1.0	10.5	115	C <sub>L</sub> = 50 pF
t <sub>PLH</sub>	Propagation Delay Time	$3.3\pm0.3$		6.3	10.1	1.0	12.0	ns	C <sub>L</sub> = 15 pF
t <sub>PHL</sub>	$(\overline{MR} \text{ to } Q_n \text{ or } \overline{Q}_n)$			8.8	13.6	1.0	15.5	115	C <sub>L</sub> = 50 pF
		$5.0 \pm 0.5$		4.3	6.4	1.0	7.5	ns	C <sub>L</sub> = 15 pF
				5.8	8.4	1.0	9.5	115	C <sub>L</sub> = 50 pF
t <sub>OSLH</sub>	Output to	$3.3 \pm 0.3$			1.5		1.5		C <sub>L</sub> = 50 pF
toshl	Output Skew								
		$5.0 \pm 0.5$			1.0		1.0		C <sub>L</sub> = 50 pF
						. a 35	T //2		(Note 4)
C <sub>IN</sub>	Input Capacitance			4	10 🦼	- 34	10	pF	V <sub>CC</sub> = Open
C <sub>PD</sub>	Power Dissipation			44	12	9-	CAL	pF	(Note 5)
	Capacitance			40	7	-4	1	ĺ	

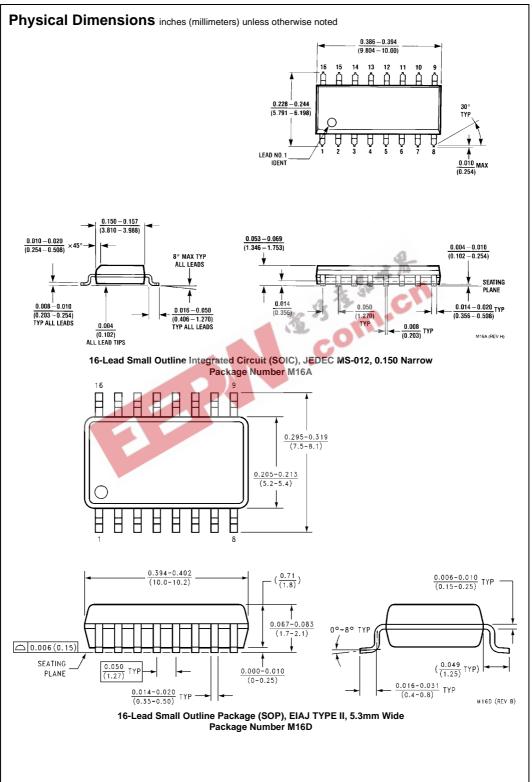
Note 4: Parameter guaranteed by design.  $t_{OSLH} = |t_{PLHmax} - t_{PLHmin}|$ ;  $t_{OSLL} = |t_{PLLmax} - t_{PLLmin}|$ .

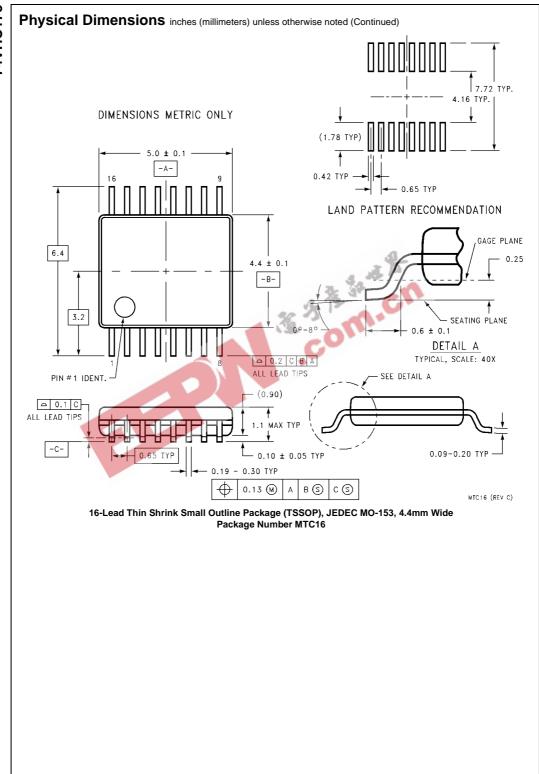
Note 5:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:  $t_{CC}$  (opr.) =  $C_{PD}$  \*  $V_{CC}$  \*  $t_{[N} + t_{CC}/4$  (per F/F), and the total  $C_{PD}$  when n pcs of the Flip-Flop operate can be calculated by the following equation:  $C_{PD}$  (total) = 30 + 14 \* n

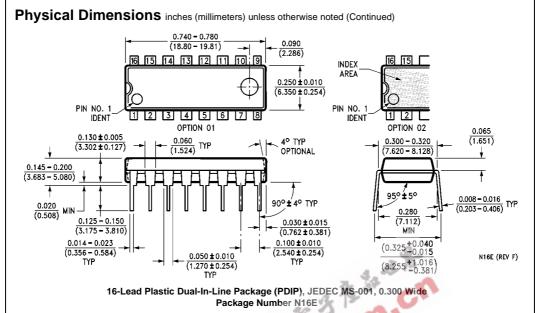
## **AC Operating Requirements**

Symbol	Parameter	V <sub>CC</sub> (V) (Note 6)	T <sub>A</sub> = 25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	
			Тур	Guara	inteed Minimum	Units
t <sub>W</sub> (L)	Minimum Pulse Width (CP)	3.3		5.0	5.0	
$t_W(H)$		5.0		5.0	5.0	ns
t <sub>W</sub> (L)	Minimum Pulse Width (MR)	3.3		5.0	5.0	ns
		5.0		5.0	5.0	115
t <sub>S</sub>	Minimum Setup Time (Dn to CP)	3.3		5.0	5.0	ns
		5.0		4.0	4.0	
t <sub>H</sub>	Minimum Hold Time (Dn to CP)	3.3		1.0	1.0	ns
		5.0		1.0	1.0	
t <sub>REC</sub>	Minimum Removal Time (MR)	3.3		5.0	5.0	ns
		5.0		5.0	5.0	

Note 6:  $V_{CC}$  is  $3.3 \pm 0.3 \text{V}$  or  $5.0 \pm 0.5 \text{V}$ 







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